

#2 pre Amended A
12-19-01
R. Steiner

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

SEKO, Toshiharu

Atty. Ref.: 925-214

Serial No. unknown

Group:

Filed: October 12, 2001

Examiner:

For: TAPE FOR CHIP ON FILM AND SEMICONDUCTOR THEREWITH

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October 12, 2001

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

PRELIMINARY AMENDMENT

Please amend the above-identified application as follows:

IN THE CLAIMS

Please substitute the following amended claim 18 for the corresponding claim 18 previously presented. A copy of the amended claim 18 showing current revisions is attached.

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18. A semiconductor device comprising a semiconductor element mounted on the tape
for chip on film as defined in Claim 1 and sealed with resin.

TOP SECRET


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REMARKS

Attached hereto is a marked-up version of the changes made to the specification and claims by the current amendment. The attached page/s is/are captioned "**Version With Markings To Show Changes Made.**"

Respectfully submitted,

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